

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
30V	8Ω@4.0V	100mA
	13Ω@2.5V	

## Feature

- Advanced trench process technology
- High density cell design for ultra low on-resistance

## Application

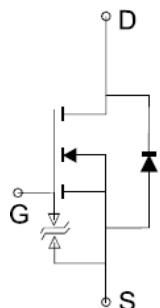
- Load Switch for Portable Devices
- DC/DC Converter

## Package

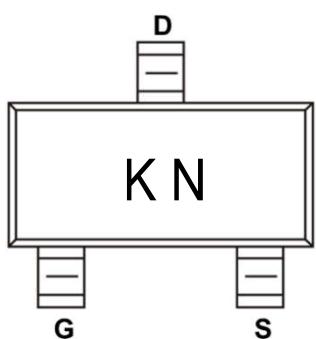


SOT-323

## Circuit diagram



## Marking



**Absolute maximum ratings (Ta=25C° unless otherwise noted)**

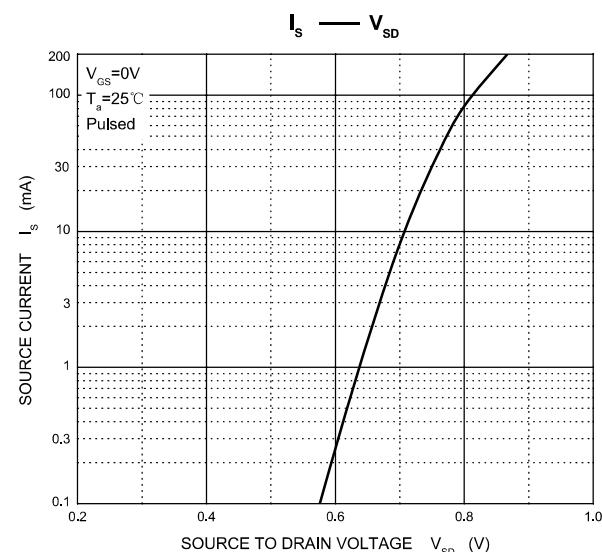
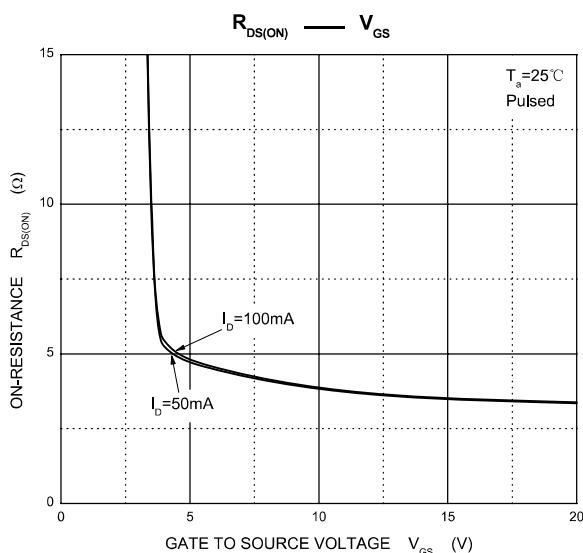
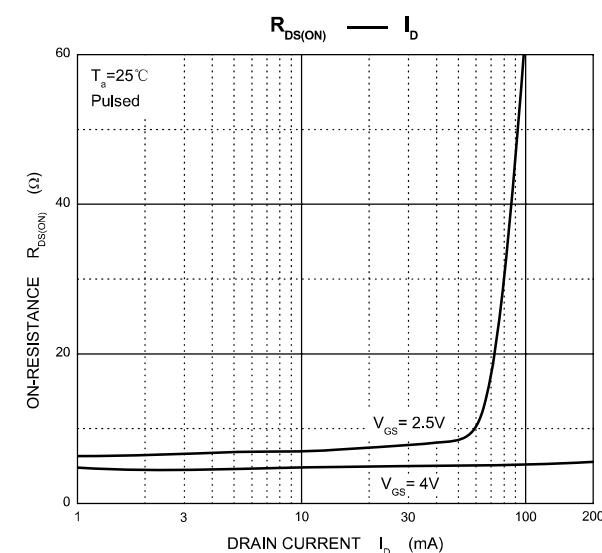
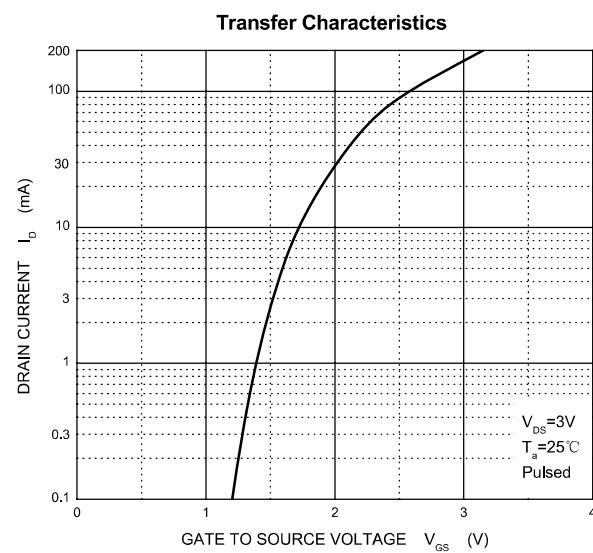
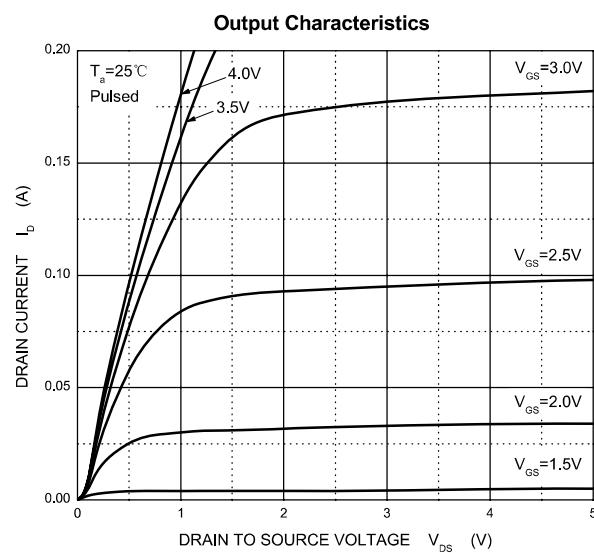
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	0.1	A
Power Dissipation	P <sub>D</sub>	0.2	W
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	625	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

**Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)**

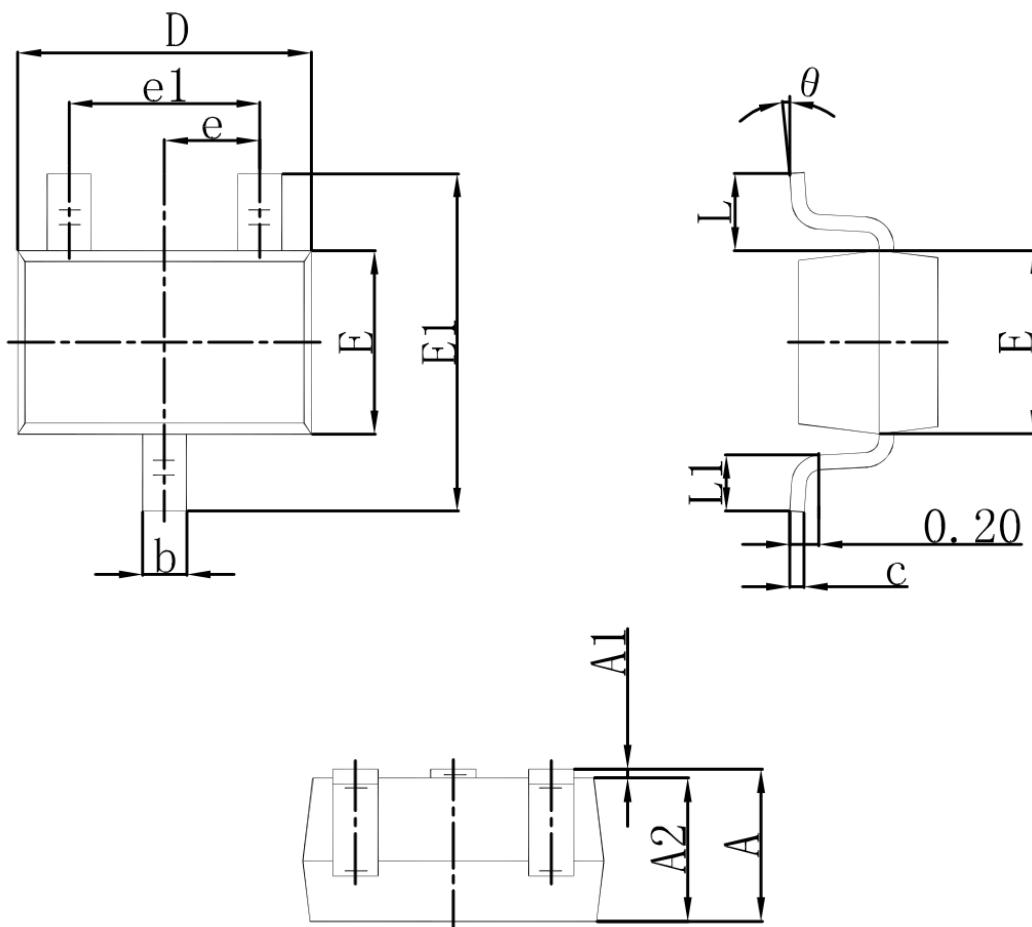
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 10µA	30			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V			0.2	µA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V V <sub>DS</sub> = 0V			±500	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = 3V , I <sub>D</sub> = 100µA	0.8		1.5	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 10mA		5	8	Ω
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 1mA		10	13	
Forward transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 3V, I <sub>D</sub> = 10mA	20			mS
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 5V, V <sub>GS</sub> = 0V, f = 1MHz		13		pF
Output Capacitance	C <sub>oss</sub>			9		
Reverse Transfer Capacitance	C <sub>rss</sub>			4		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 5V, V <sub>GS</sub> = 5V, I <sub>D</sub> = 10mA, R <sub>L</sub> = 500Ω, R <sub>GEN</sub> = 10Ω		15		nS
Turn-on rise time	t <sub>r</sub>			35		
Turn-off delay time	t <sub>d(off)</sub>			80		
Turn-off fall time	t <sub>f</sub>			80		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 0.1A			1.2	V

\*These parameters have no way to verify.

### Typical Characteristics



**SOT-323 Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.525 REF.		0.021 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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